



Towards a Carrier Grade ONAP Platform SDN Architectural Evolution

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Agenda

- Multi-vendor SDN Architectural Approach
- Multi-vendor & Cloud SDN ONAP Integration
- MC Networking Challenges & Solution Direction

Multi-vendor SDN Architectural Approach

SDN Domain Mapping

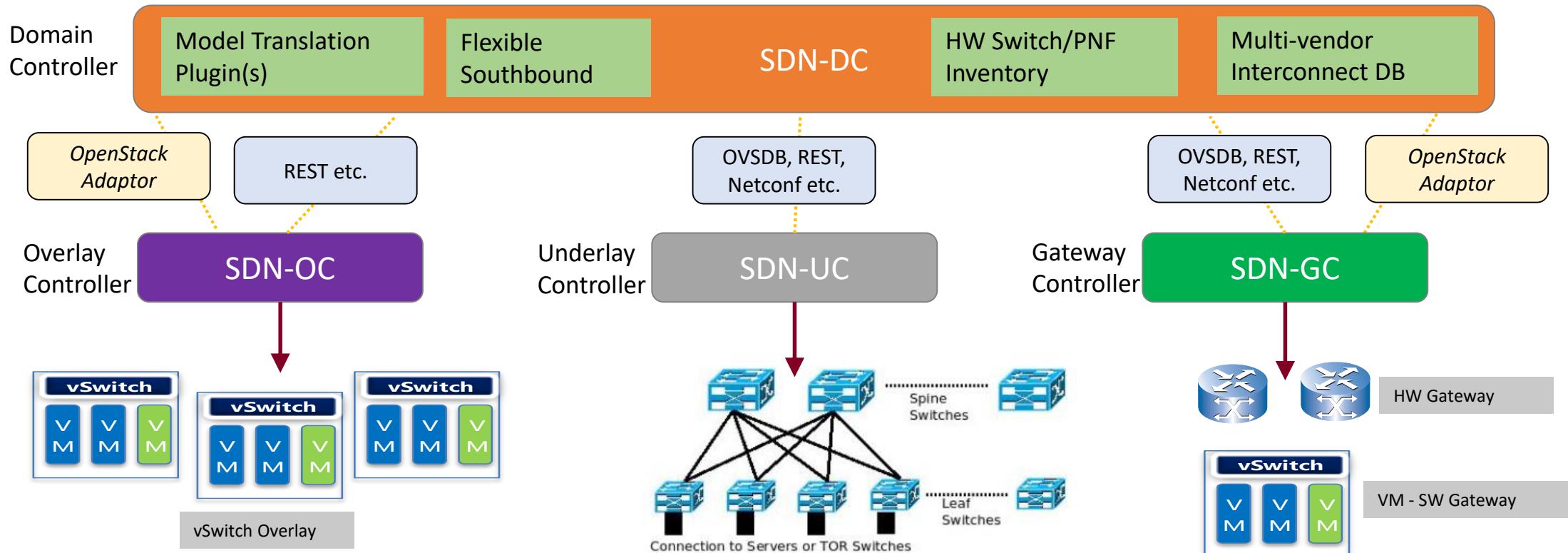
- 1 physical DC could have multiple SDN Domains
- Multiple latency bound physical DCs could map to a SDN Domain
- One Domain Controller per SDN domain

Multi-vendor Interconnect DB

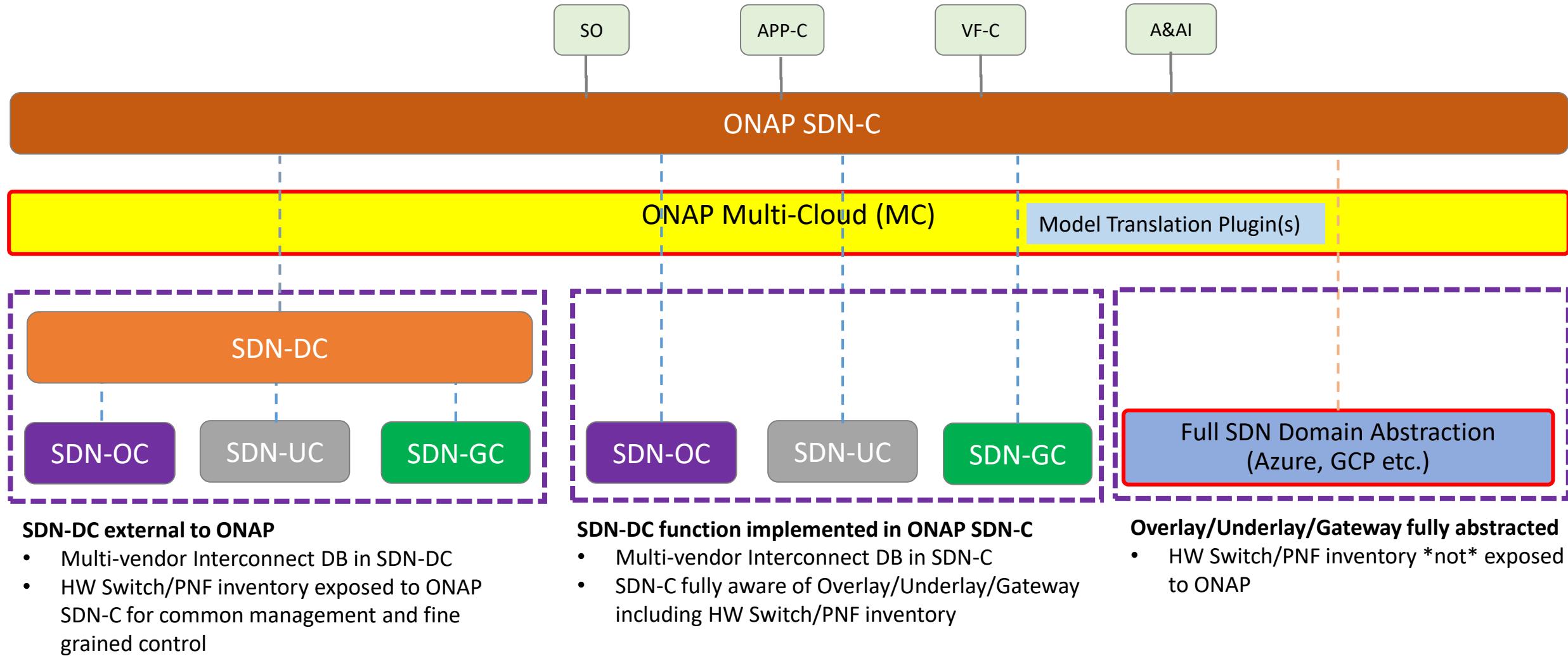
- Store interconnect information between Multi-vendor Overlay/Underlay/Gateway Controllers, for e.g. Vlan
- Function similar to SDN-C for connecting MC instance Gateway and WAN Controller

OpenStack Adaptor

- Enable smooth transformation to new Modelling Language (TOSCA, YANG etc.)



Multi-vendor & Cloud SDN ONAP Integration



MC Networking Challenges & Solution Direction

Challenge	Workflow	Need	Solution Direction
PNFs (HW Gateway etc.) and Underlay (HW Leaf/Spine switches/routers) not managed by MC instance	Day 1 & Beyond (Init and Deploy)	Foundation	PNFs and Underlay to be accounted in A&AI. SDN Domain controller function per MC instance (implemented in SDN-C or externally).
Lack of standardized APIs for MC instance Underlay Networking	All	Foundation	Standardized Data Models (TOSCA, YANG etc.), Semantics and Model-driven APIs for MC instance Underlay. Model Translation plugins translate to appropriate data model for specific Underlay Controller. Underlay configuration can be Layer 2 (MLAG etc.) or Layer 3 (eBGP etc.).
Underlay Network Configuration per MC instance not automated as part of common workflow	Day 1 (Init)	Foundation	Follow steps similar to WAN underlay Init; need to do this per MC instance.